

√RoHS

MPXH6300A, 20 to 300 kPa, Absolute, Integrated, Pressure Sensor

Freescale's MPXH6300A series sensor integrates on-chip, bipolar op amp circuitry and thin film resistor networks to provide a high output signal and temperature compensation. The small form factor and high reliability of on-chip integration make the Freescale pressure sensor a logical and economical choice for the system designer.

The MPXH6300A series piezoresistive transducer is a state-of-the-art, monolithic, signal conditioned, silicon pressure sensor. This sensor combines advanced micromachining techniques, thin film metallization, and bipolar semiconductor processing to provide an accurate, high level analog output signal that is proportional to applied pressure.

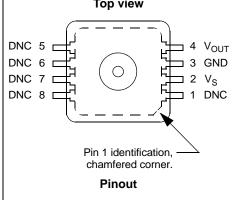
Features

- Improved accuracy at high temperature
- Available in super small outline package
- 1.5% maximum error over 0 °C to 85 °C
- Fully calibrated and compensated
- Ideally suited for microprocessor or microcontroller-based systems
- Temperature compensated from -40 °C to +125 °C
- Durable thermoplastic surface mount package
- Package porting and mounting options enable tube attachment for liquefied natural gas (LPG) or remote sensing applications

Typical applications

- Fuel injected car engines
- Vehicles powered by green gases (for example LPG and CNG)
- Small engines
- Industrial controls

MPXH	6300A
Super small o	utline package
	- Contraction
MPXH6300A6U/6T1 Case 98ARH99066A	MPXH6300AC6U/6T1 Case 98ARH99089A
Тор	view



	Ordering information								
Part number	Chinning	Deekees	# of Ports		Pressure type			Device	
Fait number	Shipping	Package	None	Single	Dual	Gauge	Differential	Absolute	marking
MPXH6300A6U	Rail	98ARH99066A	•					•	MPXH6300A
MPXH6300A6T1	Tape and Reel	98ARH99066A	•					•	MPXH6300A
MPXH6300AC6U	Rail	98ARH99089A		•				•	MPXH6300A
MPXH6300AC6T1	Tape and Reel	98ARH99089A		•				•	MPXH6300A

Freescale reserves the right to change the detail specifications as may be required to permit improvements in the design of its products.

© 2007, 2010, 2012, 2015 Freescale Semiconductor, Inc. All rights reserved.





Contents

1	General Description	3
	1.1 Block diagram	3
	1.2 Pinout	3
2	Mechanical and Electrical Specifications	4
	2.1 Maximum ratings.	4
	2.2 Operating characteristics	
3	On-chip Temperature Compensation and Calibration	5
4	Package Information.	8
	4.1 Pressure (P1)/Vacuum (P2) Side Identification	8
	4.2 Minimum recommended footprint for surface mounted applications	8
	4.3 Package Dimensions	9
5	Revision History	11

Related Documentation

The MPXH6300A device features and operations are described in a variety of reference manuals, user guides, and application notes. To find the most-current versions of these documents:

1. Go to the Freescale homepage at:

http://www.freescale.com/

- 2. In the Keyword search box at the top of the page, enter the device number MPXH6300A.
- 3. In the Refine Your Result pane on the left, click on the Documentation link.



1 General Description

1.1 Block diagram

Figure 1 shows a block diagram of the internal circuitry integrated on a pressure sensor chip.

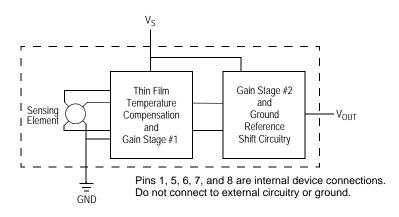


Figure 1. Integrated pressure sensor block diagram

1.2 Pinout

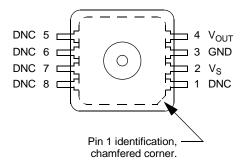


Figure 2. Device pinout (top view)

Table 1. Pin functions

Pin	Name	Function
1	DNC	Do not connect to external circuitry or ground. Pin 1 is notated by chamfered corner.
2	V _S	Voltage supply
3	GND	Ground
4	V _{OUT}	Output voltage
5	DNC	Do not connect to external circuitry or ground.
6	DNC	Do not connect to external circuitry or ground.
7	DNC	Do not connect to external circuitry or ground.
8	DNC	Do not connect to external circuitry or ground.



2 Mechanical and Electrical Specifications

2.1 Maximum ratings

Table 2. Maximum ratings⁽¹⁾

Parametrics	Symbol	Value	Units
Maximum pressure (P1 > P2)	P _{max}	1200	kPa
Storage temperature	T _{stg}	-40 to +125	°C
Operating temperature	T _A	-40 to +125	°C
Output source current @ full-scale output ⁽²⁾	l _o +	0.5	mAdc
Output sink current @ minimum pressure offset ⁽²⁾	l _o -	-0.5	mAdc

1. Exposure beyond the specified limits may cause permanent damage or degradation to the device.

2.Maximum output current is controlled by effective impedance from V_{OUT} to GND or V_{OUT} to V_S in the application circuit.

2.2 Operating characteristics

Table 3. Operating characteristics ($V_S = 5.1 V_{DC}$, $T_A = 25 \degree$ C unless otherwise noted, P1 > P2.)

Characteristic	Symbol	Min	Тур	Мах	Unit
Pressure range	P _{OP}	20	—	304	kPa
Supply voltage ⁽¹⁾	V _S	4.74	5.1	5.46	V _{DC}
Supply current	Ι _Ο		6.0	10	mAdc
Minimum pressure offset ⁽²⁾ (0 to 85 °C) @ V_S = 5.1 Volts	V _{OFF}	0.241	0.306	0.371	V _{DC}
Full-scale output ⁽³⁾ (0 to 85 °C) @ V _S = 5.1 Volts	V _{FSO}	4.847	4.912	4.977	V _{DC}
Full-scale span ⁽⁴⁾ (0 to 85 °C) @ $V_S = 5.1$ Volts	V _{FSS}	4.476	4.606	4.736	V _{DC}
Accuracy ⁽⁵⁾ (0 to 85 °C)	—	—	—	±1.5	%V _{FSS}
Sensitivity	V/P		16.2	_	mV/kPa
Response time ⁽⁶⁾	t _R	—	1.0	—	ms
Warm-up time ⁽⁷⁾	_		20	_	ms
Offset stability ⁽⁸⁾	_	_	±0.25	_	%V _{FSS}

1. Device is ratiometric within this specified excitation range.

2.Offset (V_{OFF}) is defined as the output voltage at the minimum rated pressure.

3.Full-scale output (V_{FSO}) is defined as the output voltage at the maximum or full-rated pressure.

4. Full-scale span (V_{FSS}) is defined as the algebraic difference between the output voltage at full-rated pressure and the output voltage at the minimum rated pressures

5.Accuracy is the deviation in actual output from nominal output over the entire pressure range and temperature range as a percent of span at 25 °C due to all sources of error including the following:

Linearity: Output deviation from a straight line relationship with pressure over the specified pressure range.

Temperature hysteresis:Output deviation at any temperature within the operating temperature range, after the temperature is cycled to and from the minimum or maximum operating temperature points, with zero differential pressure applied.

Pressure hysteresis: Output deviation at any pressure within the specified range, when this pressure is cycled to and from minimum or maximum rated pressure at 25 °C

TcSpan: Output deviation over the temperature range of 0 to 85 °C, relative to 25 °C.

TcOffset: Output deviation with minimum rated pressure applied, over the temperature range of 0 to 85 °C, relative to 25 °C.

Variation from Nominal: The variation from nominal values, for offset or full-scale span, as a percent of V_{FSS}, at 25 °C.

6.Response time is defined as the time for the incremental change in the output to go from 10% to 90% of its final value when subjected to a specified step change in pressure.

7.Warm-up time is defined as the time required for the product to meet the specified output voltage after the pressure has been stabilized.

8.Offset stability is the product's output deviation when subjected to 1000 cycles of pulsed pressure, temperature cycling with bias test.



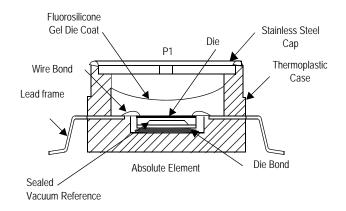
3 On-chip Temperature Compensation and Calibration

Figure 3 illustrates the absolute sensing chip in the basic super small outline chip carrier (case 98ARH99066A).

Figure 4 shows a typical application circuit (output source current operation).

Figure 5 shows the sensor output signal relative to pressure input. Typical minimum and maximum output curves are shown for operation over 0 to 85 °C temperature range. The output will saturate outside of the rated pressure range.

A fluorosilicone gel isolates the die surface and wire bonds from the environment, while allowing the pressure signal to be transmitted to the silicon diaphragm. The MPXH6300A pressure sensor operating characteristics, internal reliability and qualification tests are based on use of dry air as the pressure media. Media other than dry air may have adverse effects on sensor performance and long-term reliability. Contact the factory for information regarding media compatibility in your application.





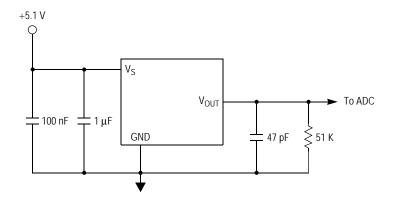


Figure 4. Recommended power supply decoupling and output filtering



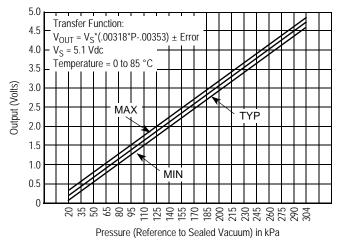
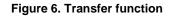
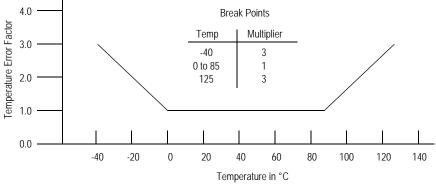


Figure 5. Output vs. absolute pressure

Nominal Transfer Value: $V_{out} = V_S x (0.00318 x P - 0.00353) \pm (Pressure Error x Temp Factor x 0.00318 x V_S) V_S = 5.1 \pm 0.36 Vdc$





NOTE: The Temperature Multiplier is a linear response from 0 °C to -40 °C and from 85 °C to 125 °C.

Figure 7. Temperature error band

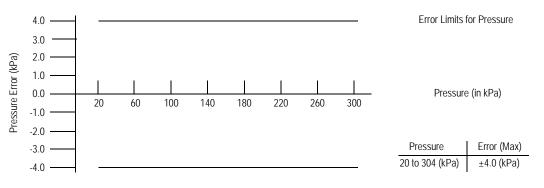


Figure 8. Pressure error band



4 Package Information

4.1 Minimum recommended footprint for surface mounted applications

Surface mount board layout is a critical portion of the total design. The footprint for the semiconductor package must be the correct size to ensure proper solder connection interface between the board and the package. With the correct pad geometry, the packages will self-align when subjected to a solder reflow process. It is always recommended to fabricate boards with a solder mask layer to avoid bridging and/or shorting between solder pads, especially on tight tolerances and/or tight layouts.

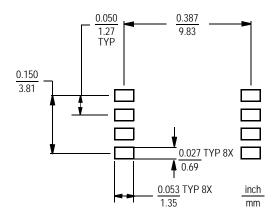
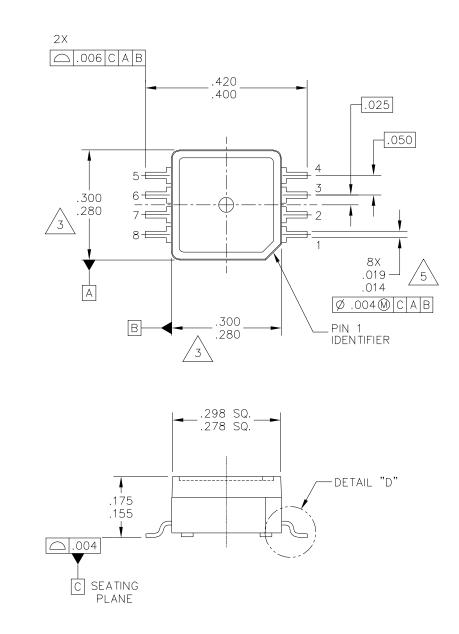


Figure 9. SSOP footprint



4.2 Package Dimensions

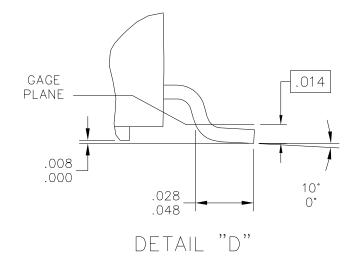
This drawing is located at http://cache.freescale.com/files/shared/doc/package_info/98ARH99066A.pdf.



	LE SEMICONDUCTOR, INC. RIGHTS RESERVED.	MECHANICAL OU	TLINE	PRINT VERSION NO	T TO SCALE
TITLE:	8 I F A D		DOCUME	NT NO: 98ARH99066A	REV: H
			CASE NU	JMBER: 1317–04	13 APR 2012
	5501		STANDAF	RD: NON-JEDEC	

Case 98ARH99066A, super small outline package, surface mount





	LE SEMICONDUCTOR, INC. RIGHTS RESERVED.	MECHANICAL OU	TLINE	PRINT VERSION NO	T TO SCALE
TITLE:	8 I F A D		DOCUME	NT NO: 98ARH99066A	REV: H
			CASE NU	JMBER: 1317-04	13 APR 2012
	5501		STANDAF	RD: NON-JEDEC	

Case 98ARH99066A, super small outline package, surface mount



NOTES:

- 1. ALL DIMENSIONS IN INCHES.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

A. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSION SHALL NOT EXCEED .006 INCHES PER SIDE.

4. ALL VERTICAL SURFACES TO BE 5' MAXIMUM.

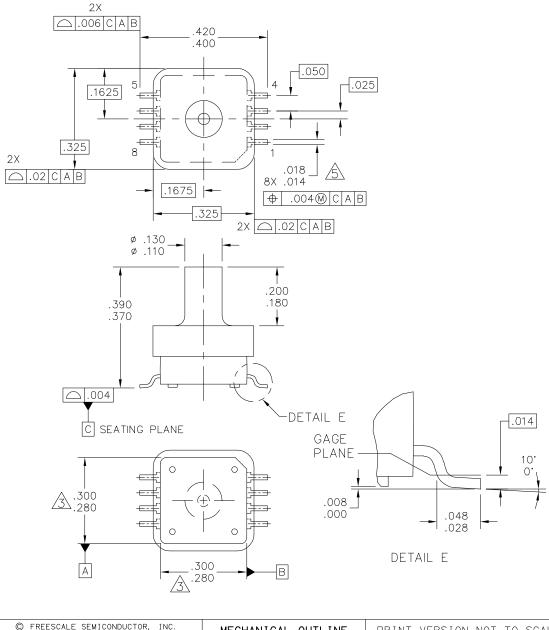
25. DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE .008 INCHES MAXIMUM.

© FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED.			PRINT VERSION NOT TO SCALE	
TITLE: 8 I F A D	DOCUME	NT NO: 98ARH99066A	REV: H	
	CASE N	UMBER: 1317-04	13 APR 2012	
	STANDA	RD: NON-JEDEC		

Case 98ARH99066A, super small outline package, surface mount



This drawing is located at http://cache.freescale.com/files/shared/doc/package_info/98ARH99089A.pdf.



© FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED.	MECHANICAL OU	TLINE	PRINT VERSION NOT	TO SCALE
TITLE:		DOCUME	NT NO: 98ARH99089A	REV: G
8 LD, PORTED	SSOP	STANDAR	RD: NON-JEDEC	
			09	NOV 2012

Case 98ARH99089A, super small outline package, surface mount



NOTES:

- 1. ALL DIMENSIONS IN INCHES.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSION SHALL NOT EXCEED .006 INCHES PER SIDE.
- 4. ALL VERTICAL SURFACES TO BE 5' MAXIMUM.
- 25. DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE .008 INCHES MAXIMUM.

© FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED.	MECHANICAL OU	TLINE	PRINT VERSION NOT TO SCALE
TITLE:		DOCUMEN	NT NO: 98ARH99089A REV: G
8 LD, PORTED	SSOP	STANDAF	RD: NON-JEDEC
			09 NOV 2012

Case 98ARH99089A, super small outline package, surface mount



5 Revision History

Table 4. Revision history

	Revision number	Revision date	Description	
	5.1	05/2012	 Updated Package Drawing 98ARH99066A was Rev. F, updated to Rev. H. 	
6.0 09/2015 • Corrected figure 4. • Updated format.		09/2015	Corrected figure 4.Updated format.	



How to Reach Us:

Home Page: freescale.com

Web Support: freescale.com/support Information in this document is provided solely to enable system and software implementers to use Freescale products. There are no express or implied copyright licenses granted hereunder to design or fabricate any integrated circuits based on the information in this document.

Freescale reserves the right to make changes without further notice to any products herein. Freescale makes no warranty, representation, or guarantee regarding the suitability of its products for any particular purpose, nor does Freescale assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters that may be provided in Freescale data sheets and/or specifications can and do vary in different applications, and actual performance may vary over time. All operating parameters, including "typicals," must be validated for each customer application by customer's technical experts. Freescale does not convey any license under its patent rights nor the rights of others. Freescale sells products pursuant to standard terms and conditions of sale, which can be found at the following address: freescale.com/salestermsandconditions.

Freescale and the Freescale logo are trademarks of Freescale Semiconductor, Inc., Reg. U.S. Pat. & Tm. Off. All other product or service names are the property of their respective owners.

© 2007, 2010, 2012, 2015 Freescale Semiconductor, Inc.

Document Number: MPXH6300A Rev. 6.0 09/2015



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Board Mount Pressure Sensors category:

Click to view products by NXP manufacturer:

Other Similar products are found below :

6407-249V-17343P 6407-250V-09273P 80527-25.0H2-05 80541-B00000150-01 80541-B00000200-05 80554-00700100-05 80568-00300050-01 93.631.4253.0 93.731.4353.0 93.932.4553.0 136PC150G2 136PC15A1 142PC95AW71 142PC05DW70 15PSI-G-4V 1805-01A-L0N-B 26PCBKT 26PCCFA6D26 26PCCFS2G 26PCCVA6D 93.632.7353.0 93.731.3653.0 93.931.4853.0 93.932.4853.0 SCDA120-XSC05DC 185PC30DH 20INCH-G-MV-MINI 26PCAFJ3G 26PCCEP5G24 26PCDFA3G 26PCJEU5G19 ASCX15AN-90 TSCSAAN001PDUCV DCAL401DN DCAL401GN XZ202798SSC XZ203676HSC 6407-249V-09343P 6407-250V-17343P SP370-25-116-0 81794-B00001200-01 HSCDLNN100PGAA5 82681-B00000100-01 81618-B0000040-05 SSCDJNN015PAAA5 TSCDLNN100MDUCV TSCSAAN100PDUCV NBPDANN015PGUNV NBPLLNS150PGUNV 142PC100D